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In re application of : **Confirmation No. 6334**
Koji MISHIMA et al. : Attorney Docket No. 2003_1305
Serial No. 10/660,483 : Group Art Unit 1742
Filed September 12, 2003 : Examiner William T. Leader

METHOD AND APPARATUS FOR PLATING
SUBSTRATE WITH COPPER

RESPONSE UNDER 37. CFR 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 1742

AMENDMENT AFTER FINAL

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

Responsive to the Office Action dated July 12, 2005, the period for response to which
having been extended by one-month to November 12, 2005, please amend the above-identified
application as follows.

Enter
W. Leader